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Innovative Service Around the Globe YAGEO

DATA SHEET

SURFACE-MOUNT CERAMIC MULTILAYER CAPACITORS

General purpose & High capacitance

Class 2, Y5V

6.3 V TO 50 V

10 nF to 47 µF

RoHS compliant & Halogen Free



YAGEO

Product Specification – March 12, 2025 V.15



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SCOPE

This specification describes Y5V series chip capacitors with lead-free terminations.

APPLICATIONS

Consumer electronics, for example:

- Tuners
- Television receivers
- Video recorders
- All types of cameras
- Mobile telephones

FEATURES

Supplied in tape on reel
Nickel-barrier end termination
RoHS compliant
Halogen Free compliant

ORDERING INFORMATION - GLOBAL PART NUMBER, PHYCOMP CTC & I2NC

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value.

YAGEO BRAND ordering code

GLOBAL PART NUMBER (PREFERRED)

CC	XXXX	X	X	Y5V	X	BB	XXX
	(1)	(2)	(3)		(4)		(5)

(1) SIZE – INCH BASED (METRIC)

0201 (0603)
0402 (1005)
0603 (1608)
0805 (2012)
1206 (3216)
1210 (3225)

(2) TOLERANCE

M = ±20%
Z = –20% to +80%

(3) PACKING STYLE

R = Paper/PE taping reel; Reel 7 inch
K = Blister taping reel; Reel 7 inch
P = Paper/PE taping reel; Reel 13 inch
F = Blister taping reel; Reel 13 inch

(4) RATED VOLTAGE

5 = 6.3 V
6 = 10 V
7 = 16 V
8 = 25 V
9 = 50 V

(5) CAPACITANCE VALUE

2 significant digits+number of zeros
The 3rd digit signifies the multiplying factor, and letter R is decimal point
Example: 103 = 10 × 10^3 = 10,000 pF = 10 nF

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CONSTRUCTION

The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (NiSn). The terminations are lead-free. A cross section of the structure is shown in Fig.1.

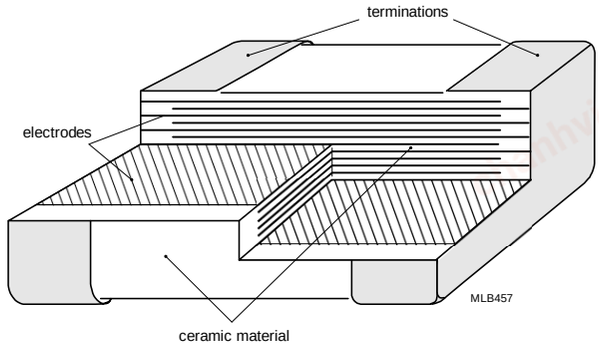


Fig. 1 Surface mounted multilayer ceramic capacitor construction

DIMENSION

Table 1 For outlines see fig. 2

TYPE	L_1 (mm)	W (mm)	T (MM)	L_2 / L_3 (mm) min.	L_2 / L_3 (mm) max.	L_4 (mm) min.
0201	0.6 ±0.03	0.3 ±0.03	Refer to table 2 to 4	0.10	0.20	0.20
0402	1.0 ±0.05	0.5 ±0.05		0.15	0.35	0.30
0603	1.6 ±0.10	0.8 ±0.10		0.20	0.60	0.40
0805	2.0 ±0.10 (1) 2.0 ±0.20 (2)	1.25 ±0.10 (1) 1.25 ±0.20 (2)		0.25	0.75	0.70
1206	3.2 ±0.15 (1) 3.2 ±0.30 (2)	1.6 ±0.15 (1) 1.6 ±0.20 (2)		0.25	0.75	1.40
1210	3.2 ±0.20 (1) 3.2 ±0.40 (2)	2.5 ±0.20 (1) 2.5 ±0.30 (2)		0.25	0.75	1.40
1812	4.5 ±0.20 (1) 4.5 ±0.40 (2)	3.2 ±0.20 (1) 3.2 ±0.40 (2)		0.25	0.75	2.20

NOTE

1. Dimension for size 0805 to 1812, C ≤ 100 nF
2. Dimension for size 0805 to 1812, C > 100 nF

OUTLINES

For dimension see Table 1

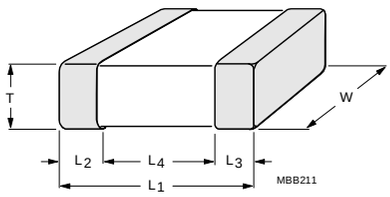


Fig. 2 Surface mounted multilayer ceramic capacitor dimension

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CAPACITANCE RANGE & THICKNESS FOR Y5V

Table 2 Sizes from 0201 to 0402

CAP.	0201		0402				
	6.3 V	25 V	6.3 V	10 V	16 V	25 V	50 V
10 nF		0.3±0.03		0.5±0.05	0.5±0.05	0.5±0.05	0.5±0.05
22 nF				0.5±0.05	0.5±0.05	0.5±0.05	
47 nF				0.5±0.05	0.5±0.05	0.5±0.05	
100 nF	0.3±0.03		0.5±0.05	0.5±0.05	0.5±0.05	0.5±0.05	
220 nF			0.5±0.05	0.5±0.05	0.5±0.05		
470 nF			0.5±0.05	0.5±0.05	0.5±0.05		
1.0 µF			0.5±0.05	0.5±0.05			
2.2 µF							
4.7 µF							
10 µF							
22 µF							
47 µF							

Table 3 Sizes from 0603 to 0805

CAP.	0603					0805				
	6.3 V	10 V	16 V	25 V	50 V	6.3 V	10 V	16 V	25 V	50 V
10 nF				0.8±0.1	0.8±0.1				0.6±0.1	0.6±0.1
22 nF				0.8±0.1	0.8±0.1				0.6±0.1	0.6±0.1
47 nF				0.8±0.1	0.8±0.1				0.85±0.1	0.85±0.1
100 nF			0.8±0.1	0.8±0.1	0.8±0.1				0.6±0.1	0.6±0.1
220 nF			0.8±0.1	0.8±0.1	0.8±0.1			0.6±0.1	0.85±0.1	0.85±0.1
470 nF			0.8±0.1	0.8±0.1				0.85±0.1	0.85±0.1	0.85±0.1
1.0 µF	0.8±0.1	0.8±0.1	0.8±0.1	0.8±0.1				0.85±0.1	0.85±0.1	1.25±0.2
2.2 µF	0.8±0.1	0.8±0.1	0.8±0.1			0.85±0.1	0.85±0.1	0.85±0.1	1.25±0.2	
4.7 µF	0.8±0.1	0.8±0.1				0.85±0.1	0.85±0.1	1.25±0.2		
10 µF						1.25±0.2	1.25±0.2			
22 µF						1.25±0.2	1.25±0.2			
47 µF										

NOTE

1. Values in shaded cells indicate thickness class in mm
2. Capacitance value of non E-3 series is on request

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CAPACITANCE RANGE & THICKNESS FOR Y5V

Table 4 Sizes from 1206 to 1210

CAP.	1206					1210				
	6.3 V	10 V	16 V	25 V	50 V	6.3 V	10 V	16 V	25 V	50V
10 nF				0.85±0.1	0.85±0.1					
22 nF				0.85±0.1	0.85±0.1					
47 nF				0.85±0.1	0.85±0.1					
100 nF				0.6±0.1	0.6±0.1					
220 nF				0.6±0.1	0.6±0.1					
470 nF				0.85±0.1	0.85±0.1					
1.0 µF			0.85±0.1	0.85±0.1	0.85±0.1					
2.2 µF		0.85±0.1	0.85±0.1	0.85±0.1						
4.7 µF		0.85±0.1	0.85±0.1							
10 µF	0.85±0.1	0.85±0.1	1.15±0.1	1.6±0.2		1.5±0.1	1.5±0.1	1.5±0.1	1.5±0.1	1.5±0.1
22 µF	1.6±0.2	1.6±0.2	1.6±0.2			1.6±0.2	1.6±0.2	1.6±0.2		
47 µF										

NOTE

1. Values in shaded cells indicate thickness class in mm
2. Capacitance value of non E-3 series is on request

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THICKNESS CLASSES AND PACKING QUANTITY

Table 5

SIZE CODE	THICKNESS CLASSIFICATION	TAPE WIDTH QUANTITY PER REEL	Ø180 MM / 7 INCH		Ø330 MM / 13 INCH		QUANTITY PER BULK CASE
			Paper	Blister	Paper	Blister	
0201	0.3 ±0.03 mm	8 mm	15,000	---	50,000	---	---
0402	0.5 ±0.05 mm	8 mm	10,000	---	50,000	---	50,000
0603	0.8 ±0.1 mm	8 mm	4,000	---	15,000	---	15,000
0805	0.6 ±0.1 mm	8 mm	4,000	---	20,000	---	10,000
	0.85 ±0.1 mm	8 mm	4,000	---	15,000	---	8,000
	1.25 ±0.2 mm	8 mm	---	3,000	---	10,000	5,000
1206	0.6 ±0.1 mm	8 mm	4,000	---	20,000	---	---
	0.85 ±0.1 mm	8 mm	4,000	---	15,000	---	---
	1.00 / 1.15 ±0.1 mm	8 mm	---	3,000	---	10,000	---
	1.25 ±0.2 mm	8 mm	---	3,000	---	10,000	---
	1.6 ±0.15 mm	8 mm	---	2,500	---	10,000	---
	1.6 ±0.2 mm	8 mm	---	2,000	---	10,000	---
1210	0.6 / 0.7 ±0.1 mm	8 mm	---	4,000	---	15,000	---
	0.85 ±0.1 mm	8 mm	---	4,000	---	10,000	---
	1.15 ±0.1 mm	8 mm	---	3,000	---	10,000	---
	1.15 ±0.15 mm	8 mm	---	3,000	---	10,000	---
	1.25 ±0.2 mm	8 mm	---	3,000	---	---	---
	1.5 ±0.1 mm	8 mm	---	2,000	---	---	---
	1.6 / 1.9 ±0.2 mm	8 mm	---	2,000	---	---	---
	2.0 ±0.2 mm	8 mm	---	2,000 1,000	---	---	---
	2.5 ±0.2 mm	8 mm	---	1,000 500	---	---	---

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ELECTRICAL CHARACTERISTICS

Y5V DIELECTRIC CAPACITORS; NISN TERMINATIONS

Unless otherwise specified, all test and measurements shall be made under standard atmospheric conditions for testing as given in 5.3 of IEC 60068-1:

- Temperature: 15 °C to 35 °C
- Relative humidity: 25% to 75%
- Air pressure: 86 kPa to 106 kPa

Before the measurements are made, the capacitor shall be stored at the measuring temperature for a time sufficient to allow the entire capacitor to reach this temperature.

The period as prescribed for recovery at the end of a test is normally sufficient for this purpose.

Table 6

DESCRIPTION			VALUE
Capacitance range			10 nF to 22 µF
Capacitance tolerance			±20% –20% to +80%
Dissipation factor (D.F.)	≤ 6.3 V		≤ 15%
		Exception: 0805 ≥ 22 µF	≤ 20%
	10 V		≤ 12.5%
		Exception: 0402 ≥ 680 nF; 0603 ≥ 2.2 µF; 0805 = 10 µF;	≤ 15%
		0805 ≥ 22 µF; 1206 ≥ 10 µF	≤ 20%
	16 V		≤ 12.5%
		Exception: 0603 ≥ 4.7 µF	≤ 15%
		1206 ≥ 10 µF	≤ 20%
	≥ 25 V		≤ 9%
		Exception: 0201 ≥ 10 nF	≤ 12.5%
Insulation resistance after 1 minute at U_r (DC)			Rins ≥ 10 GΩ or Rins x Cr ≥ 500 Ω.F whichever is less Rins x Cr ≥ 100 Ω.F : 0603 , 4.7uF, 6.3V and 10V; 0805, 22uF, 10V; Rins x Cr ≥ 50Ω.F: 0805, 22uF, 6.3V;
Maximum capacitance change as a function of temperature (temperature characteristic/coefficient):			+22% to –82%
Operating temperature range:			–30 °C to +85 °C

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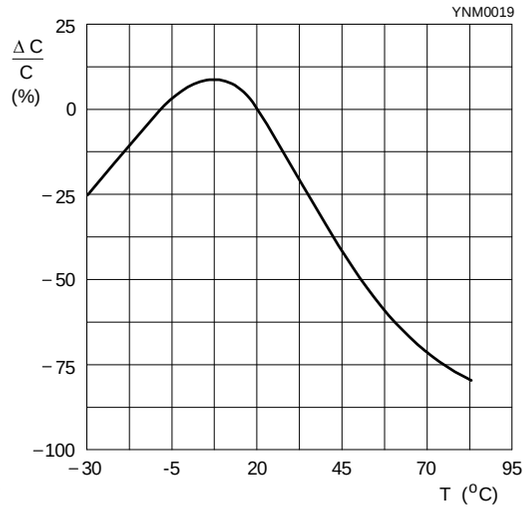


Fig. 3 Typical capacitance change as a function of temperature

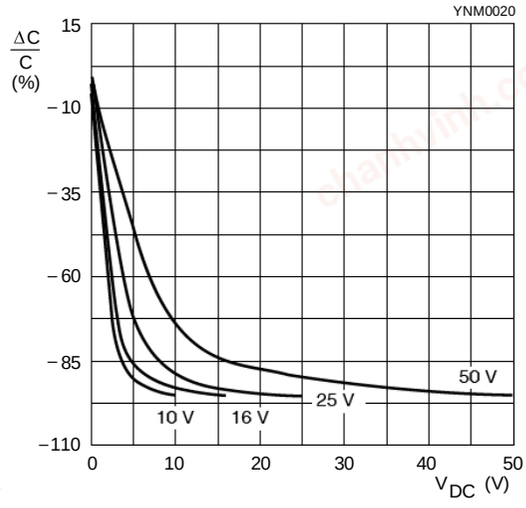


Fig. 4 Typical capacitance change with respect to the capacitance at 1 V as a function of DC voltage at 20 °C

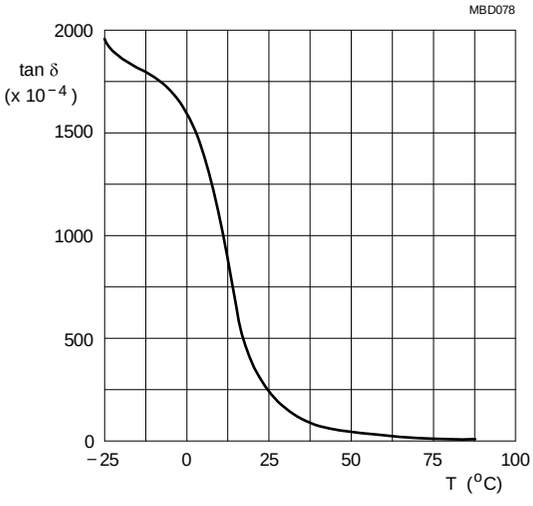


Fig. 5 Typical tan δ as a function of temperature

SOLDERING RECOMMENDATION

Table 7

SOLDERING METHOD	SIZE 0201	0402	0603	0805	1206	≥ 1210
Reflow	Reflow only	> 100 nF	> 1.0 µF	> 2.2 µF	> 2.2 µF	Reflow only
Reflow/Wave		≤ 100 nF	≤ 1.0 µF	≤ 2.2 µF	≤ 2.2 µF	---

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TESTS AND REQUIREMENTS

Table 8 Test procedures and requirements

TEST	TEST METHOD		PROCEDURE	REQUIREMENTS
Mounting	IEC 60384-21/22	4.3	The capacitors may be mounted on printed-circuit boards or ceramic substrates	No visible damage
Visual inspection and dimension check		4.4	Any applicable method using × 10 magnification	In accordance with specification
Capacitance (1)		4.5.1	Class 2: At 20 °C, 24 hrs after annealing f = 1 KHz for C ≤ 10 μF, rated voltage > 6.3 V, measuring at voltage 1 V_{rms} at 20 °C f = 1 KHz, for C ≤ 10 μF, rated voltage ≤ 6.3 V, measuring at voltage 0.5 V_{rms} at 20 °C f = 120 Hz for C > 10 μF, measuring at voltage 0.5 V_{rms} at 20 °C	Within specified tolerance
Dissipation factor (D.F.) (1)		4.5.2	Class 2: At 20 °C, 24 hrs after annealing f = 1 KHz for C ≤ 10 μF, rated voltage > 6.3 V, measuring at voltage 1 V_{rms} at 20 °C f = 1 KHz, for C ≤ 10 μF, rated voltage ≤ 6.3 V, measuring at voltage 0.5 V_{rms} at 20 °C f = 120 Hz for C > 10 μF, measuring at voltage 0.5 V_{rms} at 20 °C	In accordance with specification
Insulation resistance		4.5.3	At U_r (DC) for 1 minute	In accordance with specification
Temperature characteristic		4.6	Class 2: Between minimum and maximum temperature Y5V: -30 °C to +85 °C Normal Temperature: 20 °C	<General purpose series> ΔC/C Class 2: Y5V: 22% to -82% <High Capacitance series> ΔC/C Class 2: Y5V: 22% to -82%
Adhesion		4.7	A force applied for 10 seconds to the line joining the terminations and in a plane parallel to the substrate	Force size ≥ 0603: 5N size = 0402: 2.5N size = 0201: 1N

NOTE:

1. For individual product specification, please contact local sales.

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TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Bending strength	IEC 60384-21/22 4.8	Mounting in accordance with IEC 60384-22 paragraph 4.3 Conditions: bending 1 mm at a rate of 1 mm/s, radius jig 5 mm	No visible damage <General purpose series> ΔC/C Class2: Y5V: ±10% <High Capacitance series> ΔC/C Class2: Y5V: ±10%
Resistance to soldering heat	4.9	Precondition: 150 +0/–10 °C for 1 hour, then keep for 24 ±1 hours at room temperature Preheating: for size ≤ 1206: 120 °C to 150 °C for 1 minute Preheating: for size >1206: 100 °C to 120 °C for 1 minute and 170 °C to 200 °C for 1 minute Solder bath temperature: 260 ±5 °C Dipping time: 10 ±0.5 seconds Recovery time: 24 ±2 hours	Dissolution of the end face plating shall not exceed 25% of the length of the edge concerned <General purpose series> ΔC/C Class2: Y5V: ±20% <High Capacitance series> ΔC/C Class2: Y5V: ±20% D.F. within initial specified value R_{ins} within initial specified value
Solderability	4.10	Preheated the temperature of 80 °C to 140 °C and maintained for 30 seconds to 60 seconds. 1. Temperature: 235±5°C / Dipping time: 2 ±0.5 s 2. Temperature: 245±5°C / Dipping time: 3 ±0.5 s (lead free) Depth of immersion: 10mm	The solder should cover over 95% of the critical area of each termination

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TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Rapid change of temperature	IEC 60384-21/22 4.11	Preconditioning; 150 +0/–10 °C for 1 hour, then keep for 24 ±1 hours at room temperature 5 cycles with following detail: 30 minutes at lower category temperature 30 minutes at upper category temperature Recovery time 24 ±2 hours	No visual damage <General purpose series> ΔC/C Class2: Y5V: ±20% <High Capacitance series> ΔC/C Class2: Y5V: ±20% D.F. meet initial specified value R_{ins} meet initial specified value
Damp heat with U_r load	4.13	1. Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for 24 ±1 hour at room temp 2. Initial measure: Spec: refer initial spec C, D, IR 3. Damp heat test: 500 ±12 hours at 40 ±2 °C; 90 to 95% R.H. 1.0 U_r applied 4. Recovery: Class 2: 24 ±2 hours 5. Final measure: C, D, IR P.S. If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitor shall be precondition according to *"IEC 60384 4.1"* and then the requirement shall be met.	No visual damage after recovery <General purpose series> ΔC/C Class2: Y5V: ±30% D.F. Class2: Y5V: ≤ 15% R_{ins} Class2: Y5V: ≥ 500 MΩ or $R_{ins} \times C_r \geq 25s$ whichever is less <High Capacitance series> ΔC/C Class2: Y5V: ±30% D.F. Class2: Y5V: 2 x initial value max R_{ins} Class2: Y5V: 500 MΩ or $R_{ins} \times C_r \geq 5s$ whichever is less

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TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Endurance	IEC 60384-21/22 4.14	1. Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for 24 ±1 hour at room temp 2. Initial measure: Spec: refer initial spec C, D, IR 3. Endurance test: Temperature: Y5V: 85 °C Specified stress voltage applied for 1,000 hours: Applied 2.0 x U_r for general product. Applied 1.5 x U_r for high cap. product. 4. Recovery time: 24 ±2 hours 5. Final measure: C, D, IR P.S. If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitor shall be precondition according to *"IEC 60384 4.1"* and then the requirement shall be met.	No visual damage **<General purpose series>** ΔC/C Class2: Y5V: ±30% D.F. Class2: Y5V: ≤ 15% R_{ins} Class2: Y5V: ≥ 1,000 MΩ or $R_{ins} \times C_r \geq 50s$ whichever is less **<High Capacitance series>** ΔC/C Class 2: Y5V: ±30% D.F. Class 2: Y5V: 2 x initial value max R_{ins} Class 2: Y5V: 1,000 MΩ or $R_{ins} \times C_r \geq 10s$ whichever is less
Voltage proof	IEC 60384-1 4.6	Specified stress voltage applied for 1~5 seconds Ur ⩽100 V: series applied 2.5 Ur Charge/Discharge current is less than 50 mA	No breakdown or flashover

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REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 15	Mar, 12, 2025	-	- Update 1206, 10nF to 47nF, 25V to 50V thickness - Update 0805, 47nF, 25V to 50V thickness
Version 14	Dec. 21, 2023	-	- Update 0805, 10 µF, 10V D.F. value
Version 13	Aug. 10, 2023	-	- 1206, 1uF, 16V and 50V
Version 12	Dec. 14, 2022	-	- Add 0603, 220nF, 50V
Version 11	Oct. 05, 2021	-	- Update 0805, 1210 I.R. spec, modify 0402 L4 spec
Version 10	Apr. 29, 2021	-	- Update 1206 ≥ 10 µF, 16V Df value
Version 9	Nov. 11, 2019	-	- Add 0603, 4.7uF, 10V
Version 8	Mar. 7, 2017	-	- 0805 L4 spec updated
Version 7	Dec. 9, 2016	-	- Soldering recommendation update
Version 6	Jan. 12, 2016	-	- Update capacitance range & thickness
Version 5	Jul. 29, 2010	-	- Modify the last 2-digit of 12NC
Version 4	Jun. 24, 2010	-	- Dimension on 1206 case size updated
Version 3	Apr. 22, 2010	-	- Dimension updated
Version 2	Feb. 04, 2010	-	- The statement of "Halogen Free" on the cover added
Version 1	Nov. 04, 2009	-	- Ordering code updated - Dimension updated
Version 0	Apr. 15, 2009	-	- New datasheet for general purpose and high capacitance Y5V series with RoHS compliant - Replace the "6.3V to 50V" part of pdf files: Y5V_6.3V_10V_9_Preliminary, Y5V_10V-to-50V_10_Preliminary, Y5V_16V_25V_50V_11 - Combine 0201 from pdf files: UP-NP0X5RX7RY5V_0201_6.3-to-50V_2 and UY-NPOX5RX7RY5V_0201_6.3-to-50V_2 - Define global part number - Description of "Halogen Free compliant" added - Test method and procedure updated

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